



Part Number : [901362102](#)
Product Description : C-Grid III Header, Single Row, Vertical, Shrouded, 9 Circuits, 0.38µm Gold (Au) Selective Plating
Series Number : 90136
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings
[Drawing 901361209_sd.pdf](#)
[Packaging Design Drawing PK-90136-001-001.pdf](#)

3D Models and Design Files
[3D Model 901361209_stp.zip](#)

Specifications
[Application Specification 901190001-AS-000.pdf](#)
[Product Specification PS-99020-0001-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements
- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	90136
Description	C-Grid III Header, Single Row, Vertical, Shrouded, 9 Circuits, 0.38µm Gold (Au) Selective Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Family	C-Grid III Interconnects
Product Name	C-Grid III
UPC	800753674479

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	350V AC/DC

Physical

Breakaway	No
Circuits (Loaded)	9
Circuits (maximum)	9
Color - Resin	Black
First Mate / Last Break	No

Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Polyester
Net Weight	1.385/g
Number of Rows	1
Orientation	Vertical
Packaging Type	Tray
PC Tail Length	2.90mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	3.048µm
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-55° to +125°C
Termination Interface Style	Through Hole

Solder Process Data

Lead-Free Process Capability	WAVE
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Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid III Modular Single Row Crimp Housings	<u>90123</u>

C-Grid III Single Row Crimp Housings	<u>90156</u>
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